N-Channel 30V (D-S) MOSFET

GENERAL DESCRIPTION

The ME7802S-G is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where Low-side switching , and low in-line power loss are needed in a very small outline surface mount package.

FEATURES

- $R_{DS(ON)} \leqq 4.6m\Omega @ V_{GS}=10V$
- $R_{DS(ON)} \leqq 6.8m\Omega @ V_{GS}=4.5V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

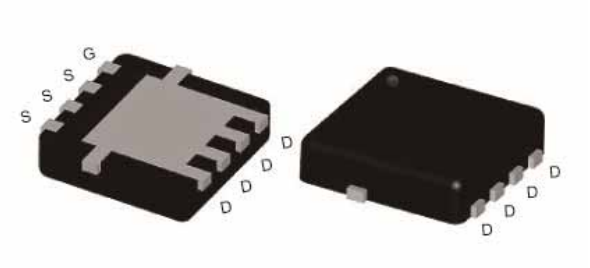
APPLICATIONS

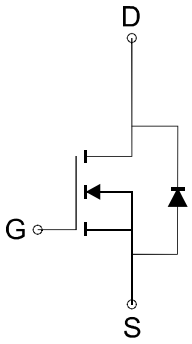
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch

PIN CONFIGURATION

(DFN 3.3x3.3)

Top View





N-Channel MOSFET

Ordering Information: ME7802S-G (Green product-Halogen free)

Absolute Maximum Ratings (T_A=25℃ Unless Otherwise Noted)

Parameter		Symbol	Maximum Ratings				Unit
Drain-Source Voltage		V_{DS}	30				V
Gate-Source Voltage		V_{GS}	±20				V
Continuous Drain Current*	T_C=25℃	I_D	84				A
	T_C=70℃		67				
	T_A=25℃		22.7				
	T_A=70℃		18.2				
Pulsed Drain Current		I_{DM}	91				A
Maximum Power Dissipation*	T_C=25℃	P_D	52				W
	T_C=70℃		33				
	T_A=25℃		3.8				
	T_A=70℃		2.4				
Operating Junction Temperature		T_J	150				℃
Storage Temperature Range		T_{stg}	-55 to 150				℃
Thermal Resistance-Junction to Ambient*		$R_{\theta JA}$	Typ	26	Max	33	℃/W
Thermal Resistance-Junction to Case*		$R_{\theta JC}$	Typ	1.9	Max	2.4	

*The device mounted on 1in^2 FR4 board with 2 oz copper

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Electrical Characteristics (T_A=25°C Unless Otherwise Specified)

Symbol	Parameter	Limit	Min	Typ	Max	Unit
STATIC						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	V_{GS}=0V, I_D=250μA	30			V
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=250μA	1.0		3.0	V
I_{GSS}	Gate Leakage Current	V_{DS}=0V, V_{GS}=±20V			±100	nA
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=30V, V_{GS}=0V			1	μA
$R_{DS(ON)}$	Drain-Source On-State Resistance[a]	V_{GS}=10V, I_D=20A		3.7	4.6	mΩ
		V_{GS}=4.5V, I_D=16A		5.4	6.8	
V_{SD}	Diode Forward Voltage	I_S=1.0A, V_{GS}=0V		0.7	1.2	V
DYNAMIC						
Qg	Total Gate Charge	V_{DS}=15V, V_{GS}=10V, I_D=20A		54		nC
Qg	Total Gate Charge	V_{DS}=15V, V_{GS}=4.5V, I_D=20A		27		
Qgs	Gate-Source Charge			9.5		
Qgd	Gate-Drain Charge			11		
Ciss	Input Capacitance	V_{DS}=15V, V_{GS}=0V, F=1MHz		2450		pF
Coss	Output Capacitance			393		
Crss	Reverse Transfer Capacitance			129		
Rg	Gate-Resistance	V_{DS}=0V, V_{GS}=0V, F=1MHz		1.8		Ω
$t_{d(on)}$	Turn-On Delay Time	V_{DD}=15V, R_L=15Ω, V_{GEN}=10V, R_G=3Ω		23		ns
t_r	Turn-On Rise Time			16		
$t_{d(off)}$	Turn-Off Delay Time			73		
t_f	Turn-Off Fall Time			12		

Note: a. Pulse test: pulse width≦ 300us, duty cycle≦ 2%, Guaranteed by design, not subject to production testing.

b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.

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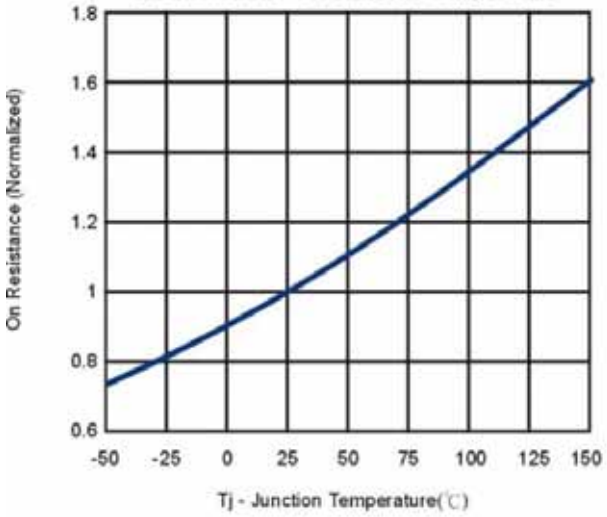
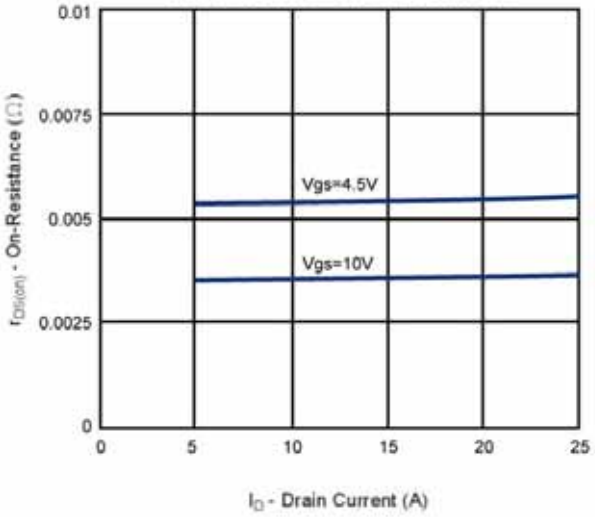
Typical Characteristics (T_J =25℃ Noted)

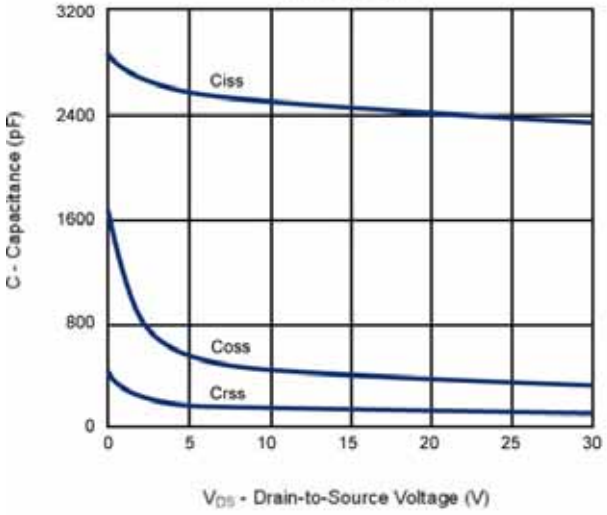
On Resistance vs. Junction Temperature



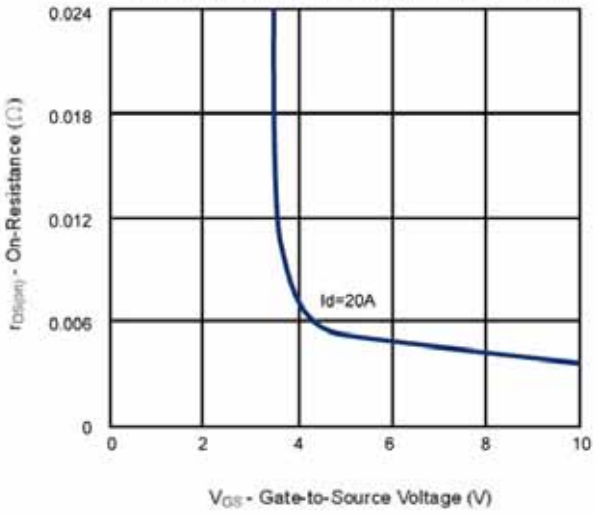
On-Resistance vs. Drain Current



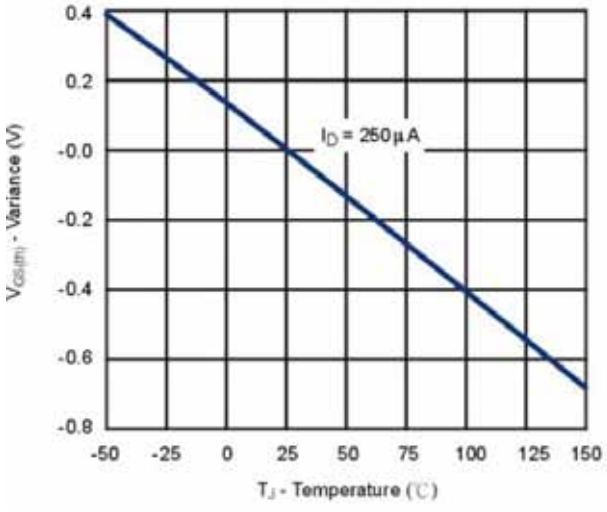
Capacitance



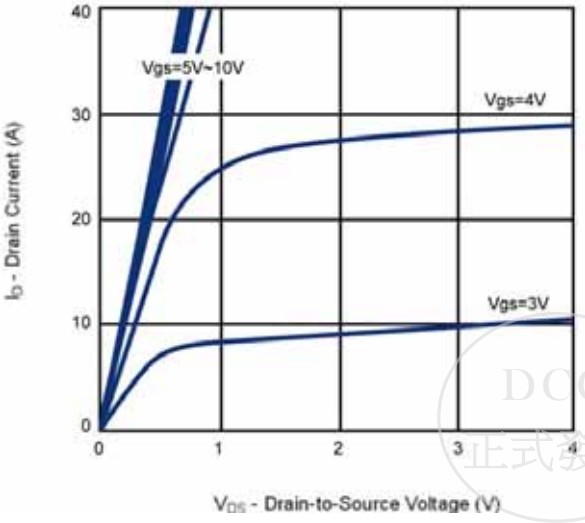
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



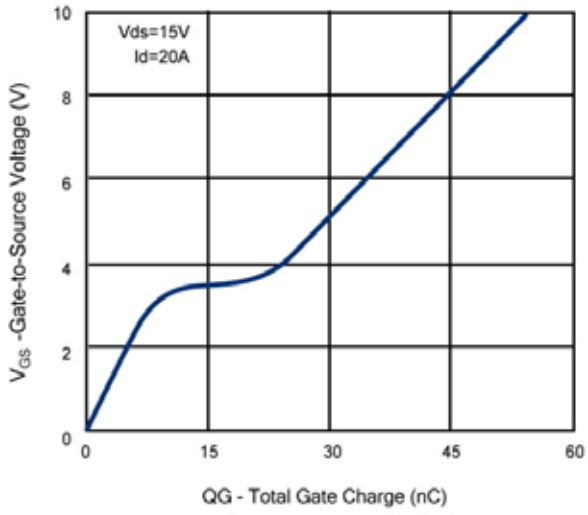
On-Region Characteristics



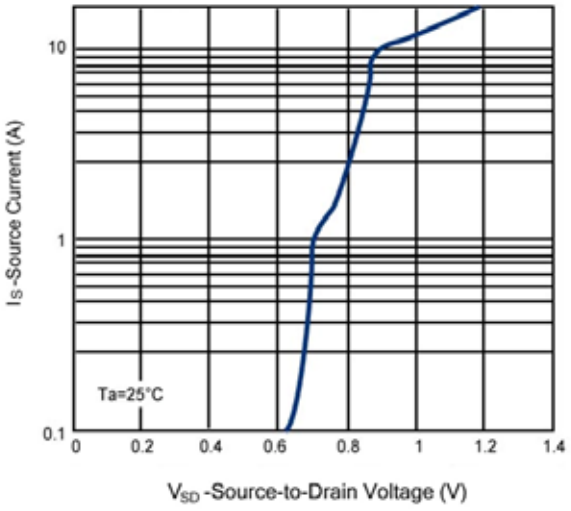
N-Channel 30V (D-S) MOSFET

Typical Characteristics (T_J =25℃ Noted)

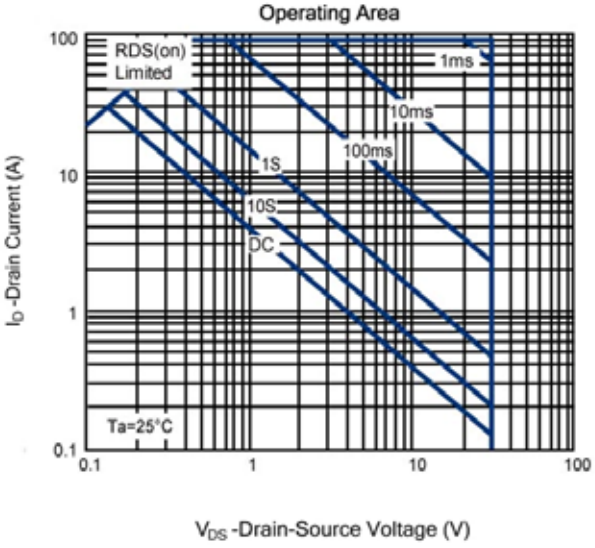
Gate Charge



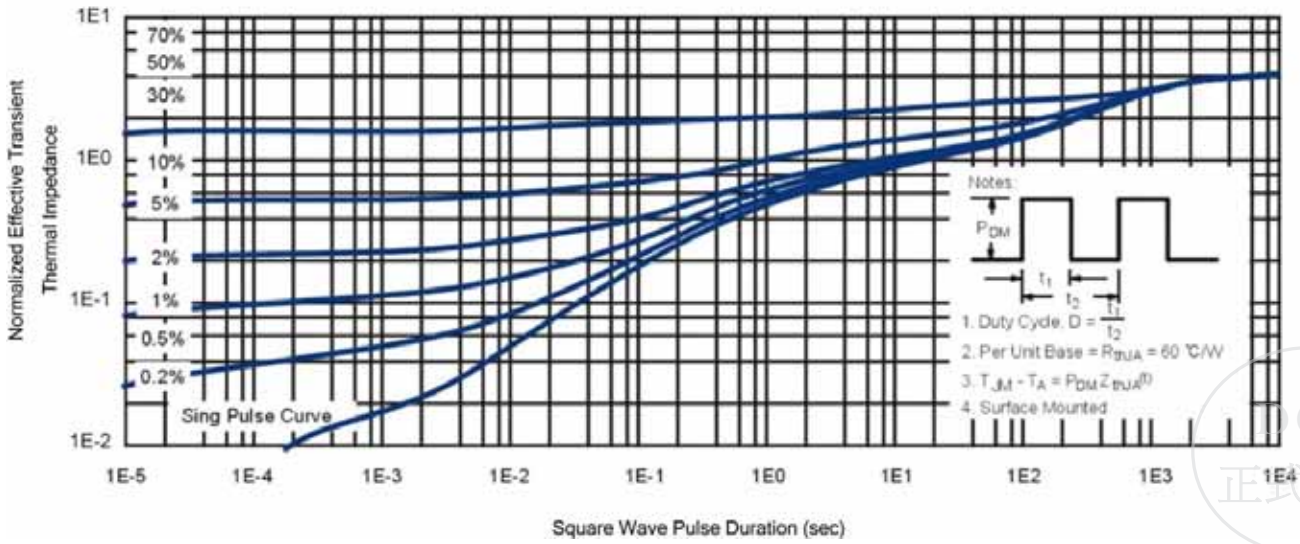
Body-diode characteristics



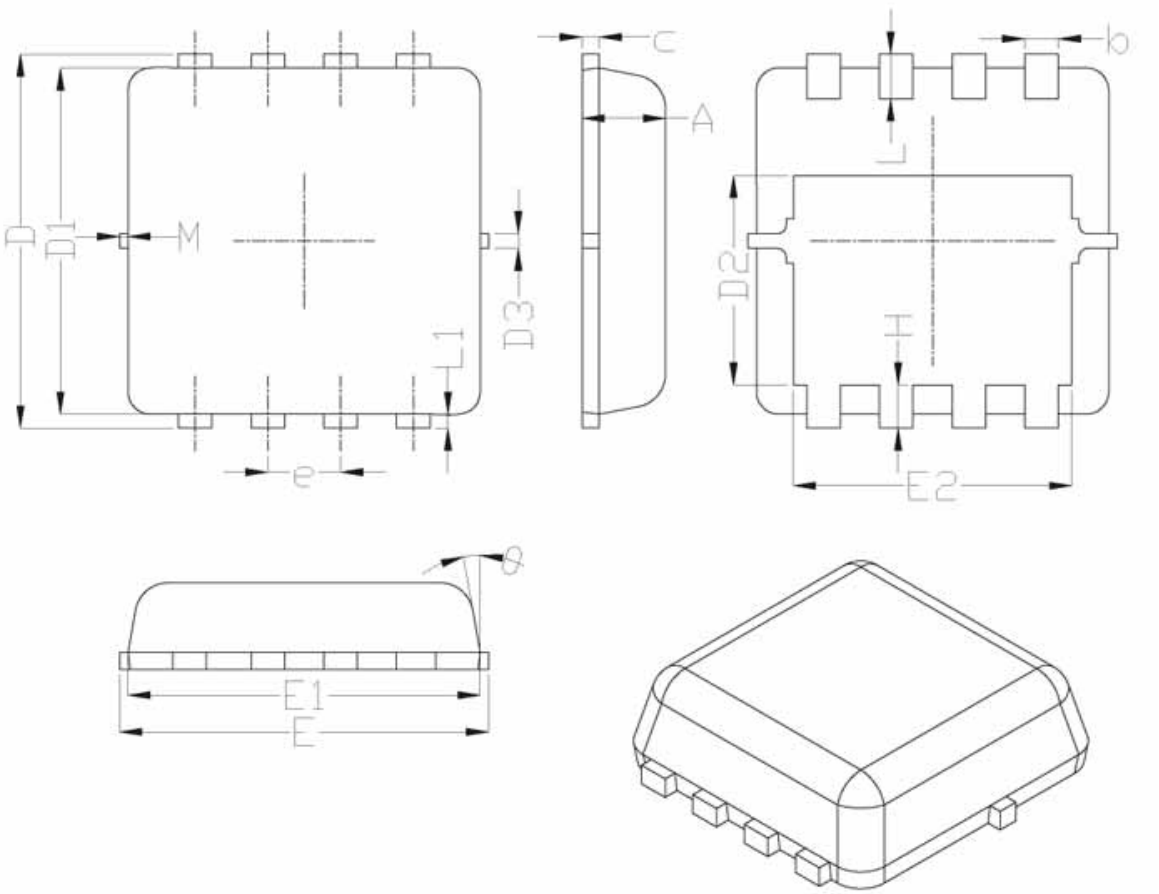
Maximum Forward Biased Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



DFN(S) 3.3x3.3 Package Outline



SYMBOL	DIMENSIONAL REQMTS		
	MIN	NOM	MAX
A	0.70	0.75	0.80
b	0.25	0.30	0.35
c	0.10	0.15	0.25
D	3.25	3.35	3.45
D1	3.00	3.10	3.20
D2	1.78	1.88	1.98
D3	---	0.13	---
E	3.20	3.30	3.40
E1	3.00	3.15	3.20
E2	2.39	2.49	2.59
e		0.65BSC	
H	0.30	0.39	0.50
L	0.30	0.40	0.50
L1	---	0.13	---
θ	---	10°	12°
M	*	*	0.15
* Not specified			